

100V N-Channel MOSFET

Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on)TYP}$ | I_D |
|---------------|-----------------|-------|
| 100V | 2.1Ω@10V | 0.17A |
| | 2.2Ω@4.5V | |

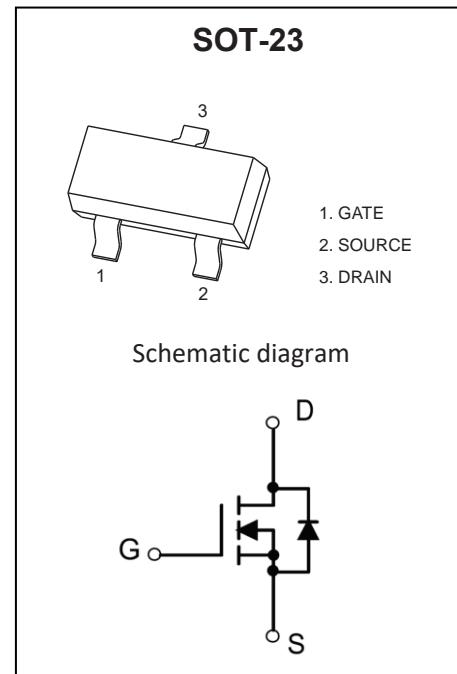
Feature

- Surface Mount Package
- High Density Cell Design for Extremely Low $R_{DS(ON)}$
- Voltage Controlled Small Signal Switch
- Rugged and Reliable
- AEC-Q101 qualified (Automotive grade with suffix "Q".)
- Exsemi technology

Application

- Small Servo Motor Controls
- Power MOSFET Gate Drivers
- Switching Application

MARKING:

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|-----------------|----------|------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current | I_D | 0.17 | A |
| Pulsed Drain Current ($t_p=10\mu\text{s}$) | I_{DM} | 0.68 | A |
| Power Dissipation | P_D | 0.35 | W |
| Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 357 | °C/W |
| Junction Temperature | T_J | 150 | °C |
| Storage Temperature | T_{STG} | -55~+150 | °C |

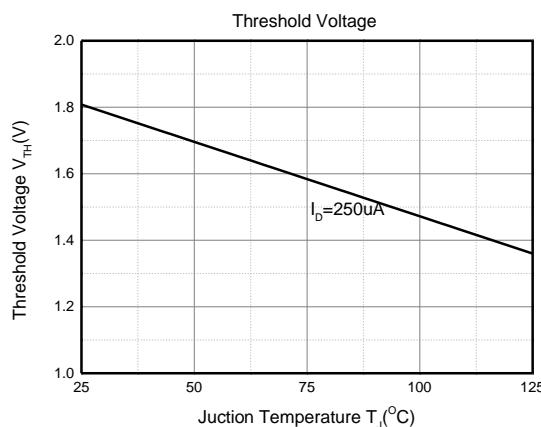
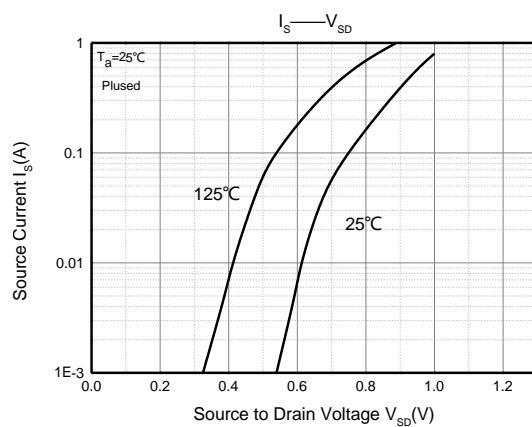
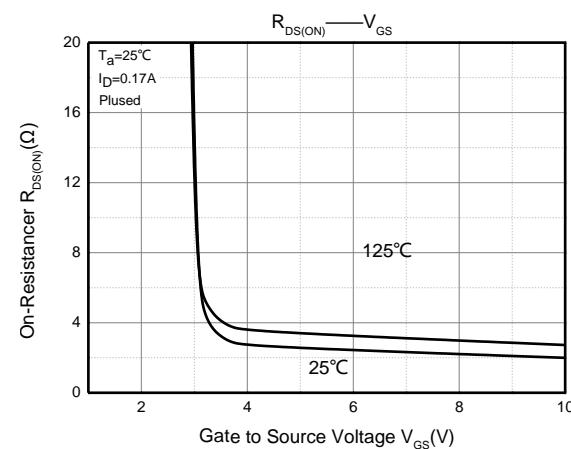
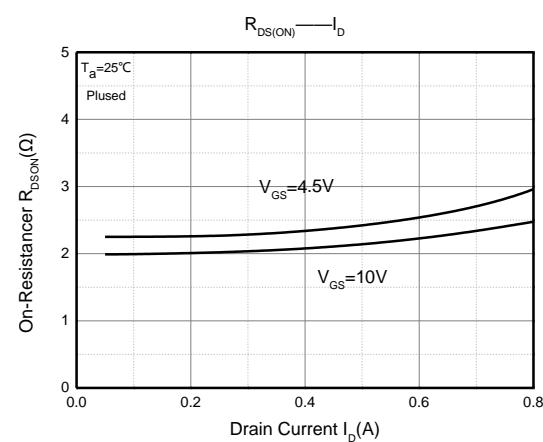
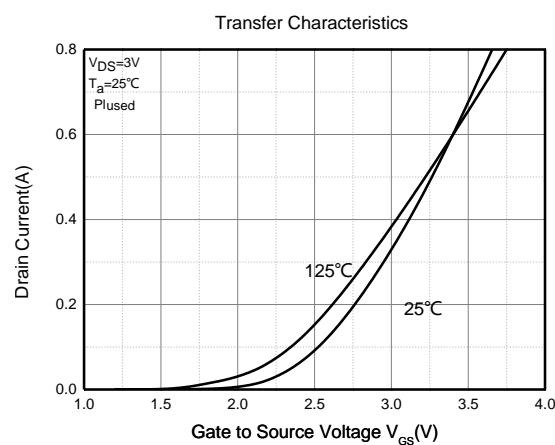
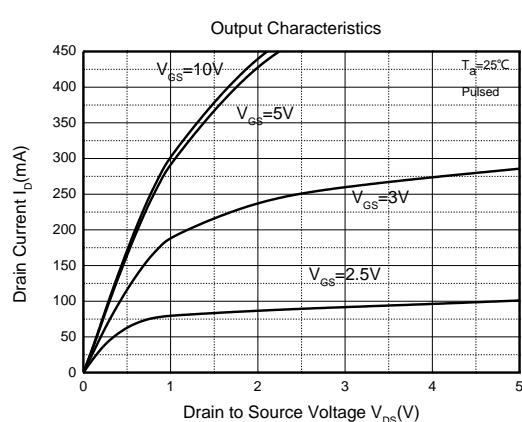
MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Test Condition | Min | Type | Max | Unit |
|---|-----------------------------|---|-----|------|-----------|---------------|
| Static Characteristics | | | | | | |
| Drain-source breakdown voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 100 | | | V |
| Zero gate voltage drain current | I_{DSS} | $V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}$ | | | 1 | μA |
| Gate-body leakage current | I_{GSS} | $V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$ | | | ± 100 | nA |
| Gate threshold voltage ¹ | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 1 | 1.8 | 3 | V |
| Drain-source on-resistance ¹ | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 0.17\text{A}$ | | 2.1 | 4.5 | Ω |
| | | $V_{\text{GS}} = 4.5\text{V}, I_D = 0.17\text{A}$ | | 2.2 | 6.0 | |
| Forward transconductance ¹ | g_{FS} | $V_{\text{DS}} = 10\text{V}, I_D = 0.17\text{A}$ | | 0.45 | | S |
| Diode forward voltage ¹ | V_{SD} | $I_S = 0.17\text{A}, V_{\text{GS}} = 0\text{V}$ | | 0.8 | 1.3 | V |
| Dynamic characteristics | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$ | | 32 | | pF |
| Output Capacitance | C_{oss} | | | 8 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 2.6 | | |
| Switching Characteristics | | | | | | |
| Turn-on delay time | $t_{\text{d}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, V_{\text{DD}} = 30\text{V}, I_D = 0.28\text{A}, R_{\text{GEN}} = 50\Omega$ | | 7 | | ns |
| Turn-on rise time | t_r | | | 6 | | |
| Turn-off delay time | $t_{\text{d}(\text{off})}$ | | | 10 | | |
| Turn-off fall time | t_f | | | 9 | | |
| Total Gate Charge | Q_g | $V_{\text{DS}} = 10\text{V}, I_D = 0.22\text{A}, V_{\text{GS}} = 10\text{V}$ | | 1.5 | | nC |
| Gate-Source Charge | Q_{gs} | | | 0.16 | | |
| Gate-Drain Charge | Q_{gd} | | | 0.2 | | |

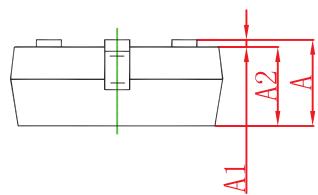
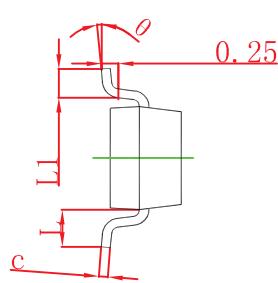
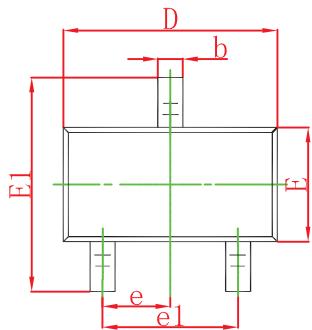
Notes :

1.Pulse Test : Pulse width=300 μs , duty cycle $\leq 2\%$.

Typical Characteristics



SOT-23 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.900 | 1.150 | 0.035 | 0.045 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.080 | 0.150 | 0.003 | 0.006 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 1.200 | 1.400 | 0.047 | 0.055 |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 |
| e | 0.950 TYP | | 0.037 TYP | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.550 REF | | 0.022 REF | |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 |
| θ | 0° | 8° | 0° | 8° |